



**N - CHANNEL ENHANCEMENT MODE
POWER MOS TRANSISTORS**

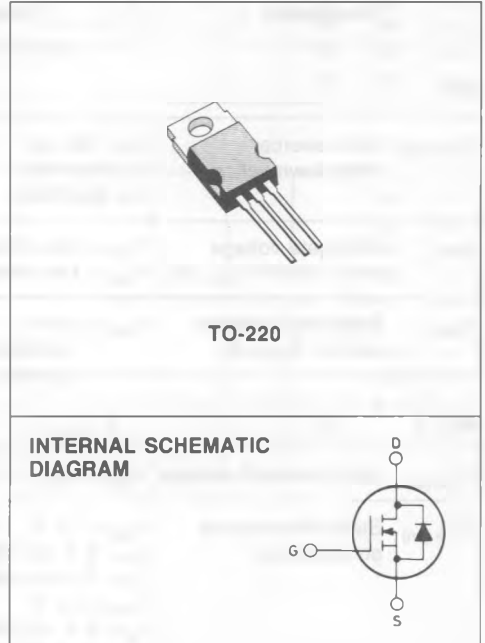
| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|---------|------------------|---------------------|----------------|
| SGSP361 | 100 V | 0.15 Ω | 18 A |
| SGSP362 | 80 V | 0.1 Ω | 22 A |

- HIGH SPEED SWITCHING APPLICATIONS
- 80 - 100 VOLTS - FOR UPS APPLICATIONS
- ULTRA FAST SWITCHING
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- EASY DRIVE FOR REDUCED SIZE AND COST

INDUSTRIAL APPLICATIONS:

- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistor. Easy drive and very fast switching times make this POWER MOS transistor ideal for high speed switching applications. Typical applications include UPS, battery chargers, printer hammer drivers, solenoid drivers and motor control.



ABSOLUTE MAXIMUM RATINGS

| | | SGSP361 | SGSP362 | |
|---------------------|---|---------|-------------|------|
| V _{DS} | Drain-source voltage (V _{GS} = 0) | 100 | 80 | V |
| V _{DGR} | Drain-gate voltage (R _{GS} = 20 KΩ) | 100 | 80 | V |
| V _{GS} | Gate-source voltage | | ± 20 | V |
| I _D | Drain current (cont.) at T _c = 25°C | 18 | 22 | A |
| I _D | Drain current (cont.) at T _c = 100°C | 11 | 14 | A |
| I _{DM} (*) | Drain current (pulsed) | 72 | 88 | A |
| P _{tot} | Total dissipation at T _c < 25°C | | 100 | W |
| | Derating factor | | 0.8 | W/°C |
| T _{stg} | Storage temperature | | - 65 to 150 | °C |
| T _j | Max. operating junction temperature | | 150 | °C |

(*) Pulse width limited by safe operating area
♦ Introduced in 1988 week 44

THERMAL DATA

| | | | | |
|----------------|--|-----|------|------|
| $R_{thj-case}$ | Thermal resistance junction-case | max | 1.25 | °C/W |
| T_L | Maximum lead temperature for soldering purpose | | 275 | °C |

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^\circ\text{C}$ unless otherwise specified)

| Parameters | Test Conditions | Min. | Typ. | Max. | Unit |
|------------|-----------------|------|------|------|------|
|------------|-----------------|------|------|------|------|

OFF

| | | | | | | |
|---------------|--|---|---------------------------|-----------|-------------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $I_D = 250 \mu\text{A}$ for SGSP361 for SGSP362 | $V_{GS} = 0$ | 100 80 | | V V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$ | $T_c = 125^\circ\text{C}$ | | 250 1000 | μA μA |
| I_{GSS} | Gate-body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |

ON (*)

| | | | | | | | |
|--------------|-----------------------------------|--|---------------------------|---|--|---------------------------|--|
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$ | $I_D = 250 \mu\text{A}$ | 2 | | 4 | V |
| $R_{DS(on)}$ | Static drain-source on resistance | $V_{GS} = 10 \text{ V}$ $I_D = 9 \text{ A}$ for SGSP361 $I_D = 11 \text{ A}$ for SGSP362 $V_{GS} = 10 \text{ V}$ $I_D = 9 \text{ A}$ for SGSP361 $I_D = 11 \text{ A}$ for SGSP362 | $T_c = 100^\circ\text{C}$ | | | 0.15 0.1 0.3 0.2 | Ω Ω Ω Ω |

ENERGY TEST

| | | | | | | | |
|-----------|--|--|-----------------------|----------|--|--|--------|
| I_{UIS} | Unclamped inductive switching current (single pulse) | $V_{DD} = 30 \text{ V}$ starting $T_j = 25^\circ\text{C}$ for SGSP361 for SGSP362 | $L = 100 \mu\text{H}$ | 18 22 | | | A A |
|-----------|--|--|-----------------------|----------|--|--|--------|

DYNAMIC

| | | | | | | | |
|-----------|------------------------------|-------------------------|---------------------|-----|-----|------|-----|
| g_{fs} | Forward transconductance | $V_{DS} = 25 \text{ V}$ | $I_D = 9 \text{ A}$ | 4.5 | | | mho |
| C_{iss} | Input capacitance | | | | 950 | 1200 | pF |
| C_{oss} | Output capacitance | $V_{DS} = 25 \text{ V}$ | $f = 1 \text{ MHz}$ | | | 480 | pF |
| C_{rss} | Reverse transfer capacitance | $V_{GS} = 0$ | | | | 230 | pF |

ELECTRICAL CHARACTERISTICS (Continued)

| Parameters | Test Conditions | Min. | Typ. | Max. | Unit |
|------------|-----------------|------|------|------|------|
|------------|-----------------|------|------|------|------|

SWITCHING

| | | | | | | |
|--------------|---------------------|------------------------|---------------------|----|----|----|
| $t_{d(on)}$ | Turn-on time | $V_{DD} = 50\text{ V}$ | $I_D = 11\text{ A}$ | 20 | 30 | ns |
| t_r | Rise time | $V_i = 10\text{ V}$ | $R_i = 4.7\ \Omega$ | 50 | 65 | ns |
| $t_{d(off)}$ | Turn-off delay time | (see test circuit) | | 65 | 85 | ns |
| t_f | Fall time | | | 25 | 35 | ns |

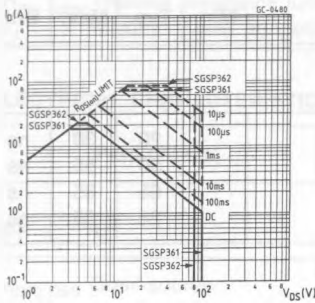
SOURCE DRAIN DIODE

| | | | | | | |
|---------------|-------------------------------|--|--------------|-----|--------------|--------|
| I_{SD} | Source-drain current | for SGSP361 for SGSP362 | | | 18 22 | A A |
| I_{SDM} (*) | Source-drain current (pulsed) | for SGSP361 for SGSP362 | | | 72 88 | A A |
| V_{SD} | Forward on voltage | $V_{GS} = 0$ $I_{SD} = 18\text{ A}$ for SGSP361 $I_{SD} = 22\text{ A}$ for SGSP362 | | | 1.35 1.35 | V V |
| t_{rr} | Reverse recovery time | $I_{SD} = 22\text{ A}$ $di/dt = 25\text{ A}/\mu\text{s}$ | $V_{GS} = 0$ | 180 | | ns |

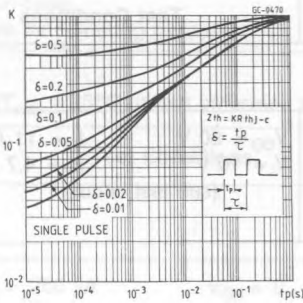
(*) Pulsed: Pulse duration = 300 μs , duty cycle 1.5%

(*) Pulse width limited by safe operating area

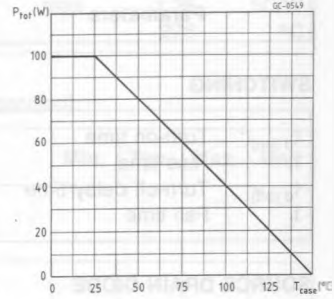
Safe operating areas



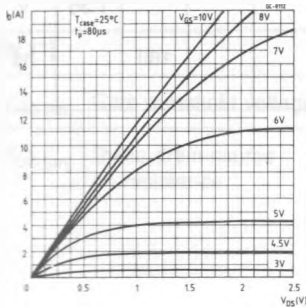
Thermal impedance



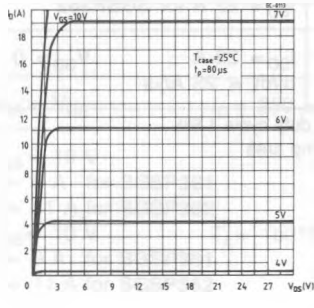
Derating curve



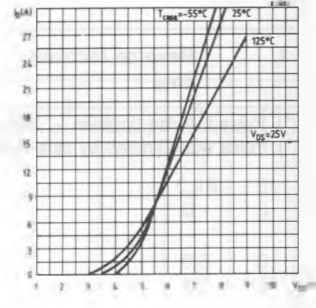
Output characteristics



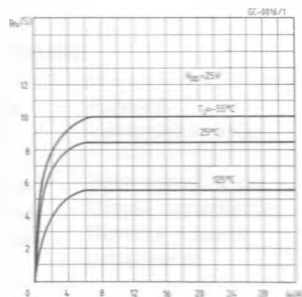
Output characteristics



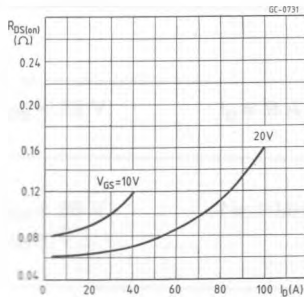
Transfer characteristics



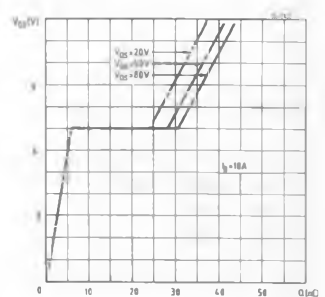
Transconductance



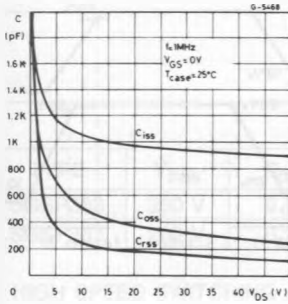
Static drain-source on resistance



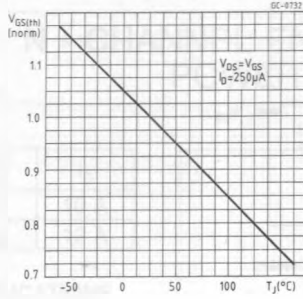
Gate charge vs gate-source voltage



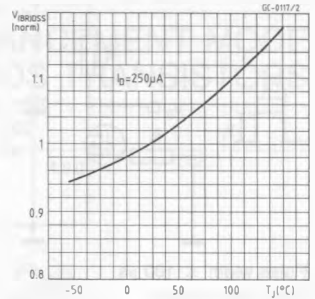
Capacitance variation



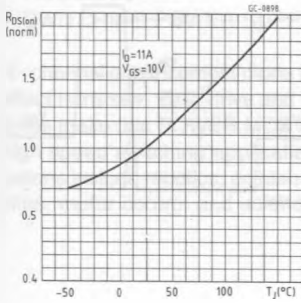
Normalized gate threshold voltage vs temperature



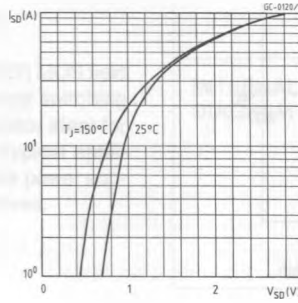
Normalized breakdown voltage vs temperature



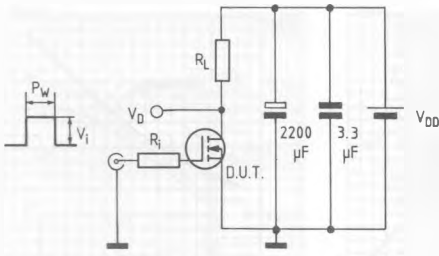
Normalized on resistance vs temperature



Source-drain diode forward characteristics



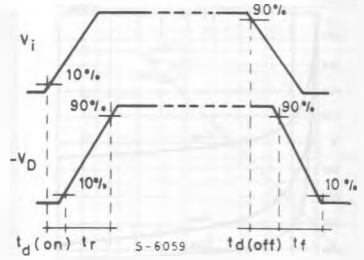
Switching times test circuit for resistive load



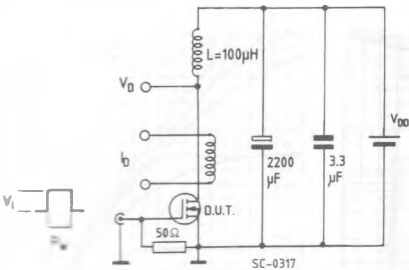
Pulse width $\leq 100 \mu\text{s}$
 Duty cycle $\leq 2\%$

SC-0008/1

Switching time waveforms for resistive load



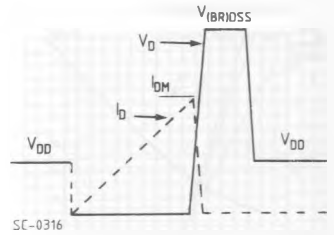
Unclamped inductive load test circuit



$V_i = 12 \text{ V}$ - Pulse width: adjusted to obtain specified I_{DM}

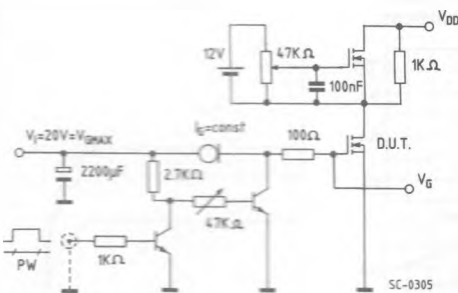
SC-0317

Unclamped inductive waveforms



SC-0316

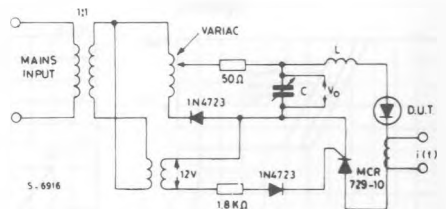
Gate charge test circuit



PW adjusted to obtain required V_G

SC-0305

Body-drain diode t_{rr} measurement
 Jedec test circuit



S. 6916